

Description

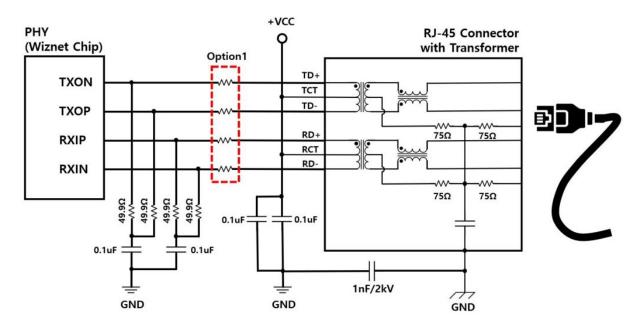
This document is a WIZnet Ethernet Chip design reference. It contains PCB design references using W5100, W5300, W5500, W6300, W7500, and W7500P. Includes Medium dependent interface (MDI), power supply, parts placement, Media Independent Interface (MII), etc. You must follow the instructions below. Failure to follow the instructions may result in poor Ethernet performance.

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✓ SCH Design Guide

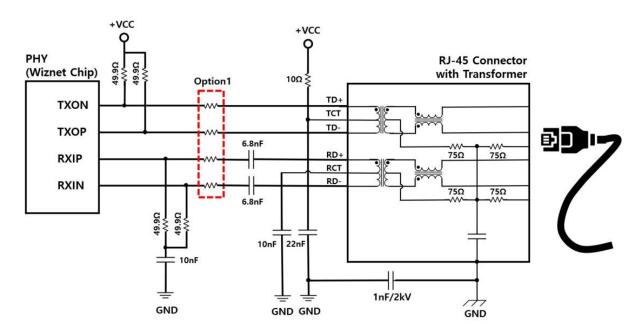
■ W5100, W5100S, W5300, W6100, W6300



- The circuit may change depending on the internal circuit configuration of the Ethernet socket.
 Make sure to refer to Datasheet and design the circuit in an appropriate way.
- If you use an Ethernet socket that does not include a transformer, you must also design the transformer part of the circuit.
- The TCT of the transformer, the GND connected to the RCT, and the GND connected to the longitudinal resistance of the TX and RX can be designed as AGND instead of the normal GND. This is for the separation of the MDI signal from the system GND noise, in which case the area of the AGND should be large enough. Otherwise, it is more advantageous to integrate AGND and system GND.
- Option1 is a damping resistance against EMC. Resistance to prevent common mode noise and differential mode noise interference; if the resistance value is designed too large, the voltage level of the differential line may decrease, which may cause Ethernet communication problems.

SCH Design Guide

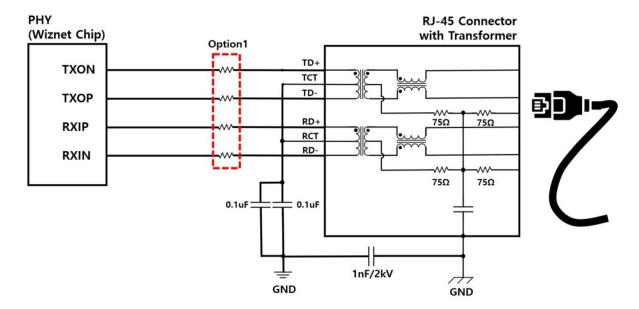
■ W5500



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✓ SCH Design Guide

■ W7500, W7500P

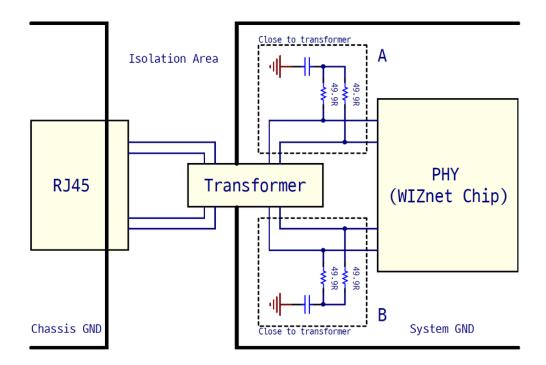


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- The Current Mode PHY has a termination resistor circuit inside, eliminating the need to design an external termination resistor.
- Since the W7500 does not have PHY, additional PHY circuits must be designed.

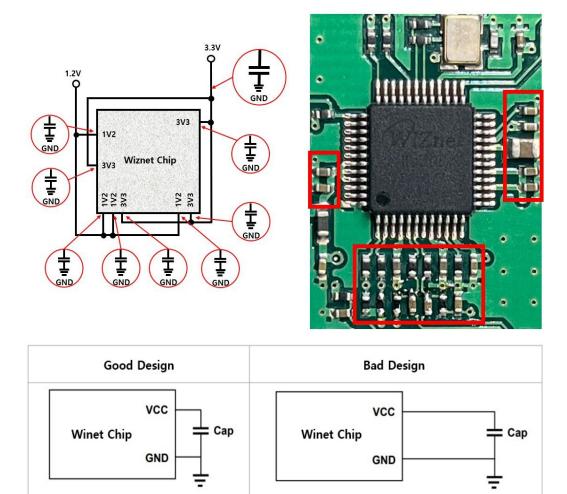
✓ SCH Design Guide

■ Using RJ-45 without Transformer



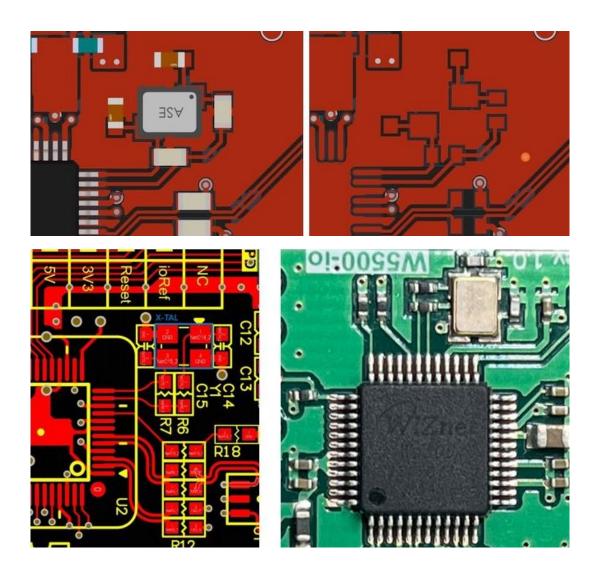
- If you use an Ethernet socket without Transformer, you must design an additional Transformer circuit.
- The above circuit is a typical circuit configuration and corresponds to W5100, W5100S,
 W5300, and W6100 on the WIZnet Ethernet Chip.
- Based on Transformer, PHY to Transformer is the System GND area.
- It is recommended that the termination resistance be placed closest to the end of the signal. (Receiving side)

■ Decoupling Capacitor



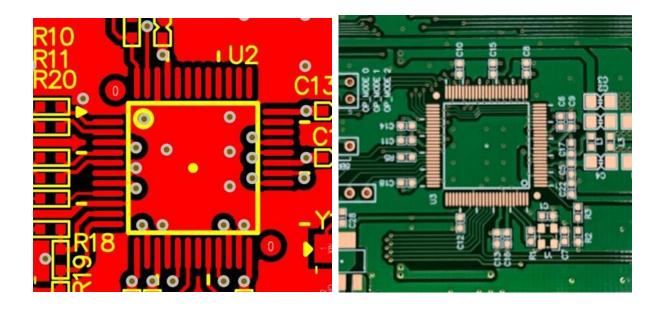
- The Decoupling Capacitor is used to remove noise from the power line.
- As filtering is the purpose, it is recommended to place it as close as possible to the chip.
- It is recommended that at least one Capacitor be designed for each power line.

Oscillator



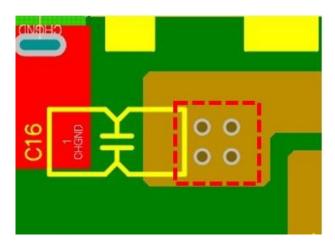
- Because it is a high-frequency signal, it is recommended to design without Via in layers such as Chip during Artwork.
- It is recommended that only one chip be connected to one oscillating element. (current problem, interference

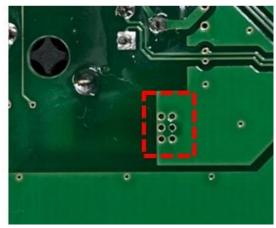
■ GND Plane

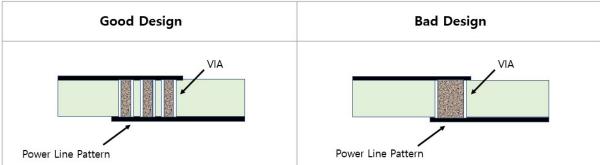


- It is also recommended to put GND Copper powder on the inside of the chip.
- It is recommended that no other digital lines pass across the chip.
- It is recommended that you place multiple Via's to maintain good GND connectivity.
- It is recommended to distinguish between AGND and DGND.
- If you separate AGND and DGND, it is not functionally good if it is located on the same coordinate even if it is a different layer.

■ Power Pattern

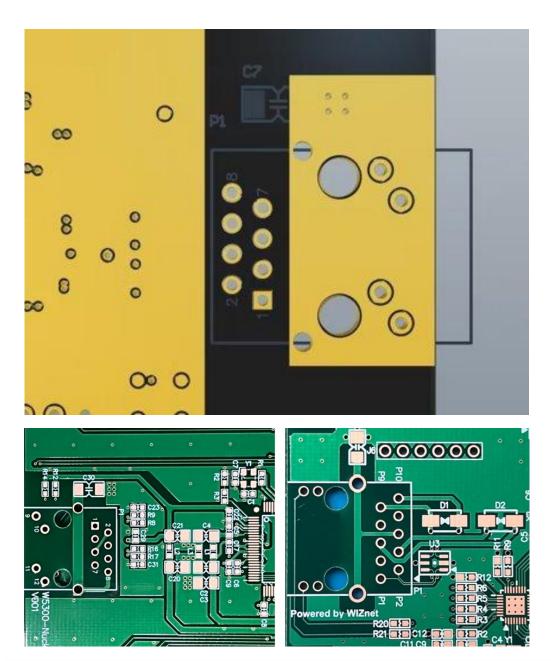






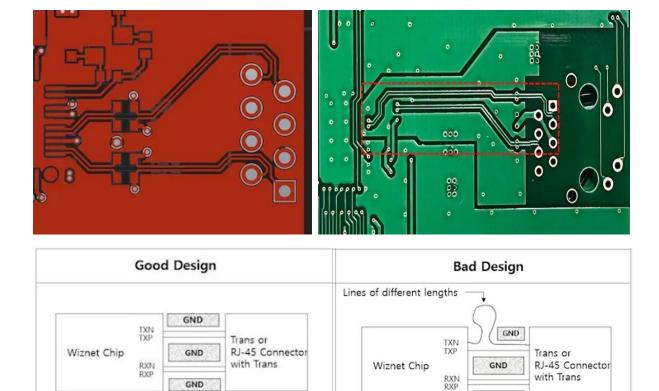
- The Power Plane should also consider Pattern and Via. The current capacity of the pattern depends on the width, thickness, OZ, and temperature.
- If possible, it is better to design with several smaller Via rather than one larger Via. (Current capacity is greater)

■ Ethernet Socket



- If you use an RJ-45 socket without Transformer, you must design the Transformer circuit additionally.
- The above circuit is a typical circuit configuration and corresponds to W5100S, W6100, and W5300 on the WIZnet Ethernet Chip.
- Based on Transformer, PHY to Transformer is the System GND area.

■ MDI

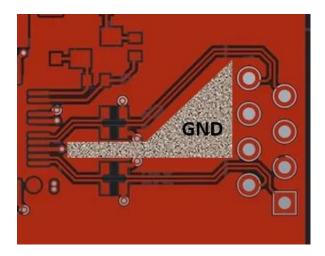


• The distance between RJ-45 and Chip should be as close as possible.

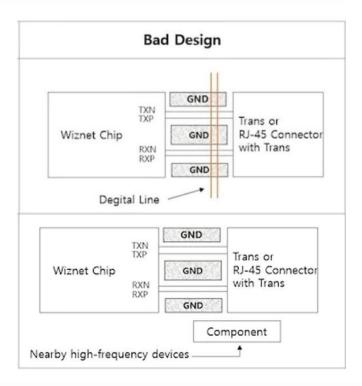
Line as short as possible

Because the Tx, Rx signals are differential signals, each line must be of the same length. If the
lines are formed differently, the differential mode signal can switch to common mode noise,
affecting EMI, and causing Ethernet communication to become a problem.

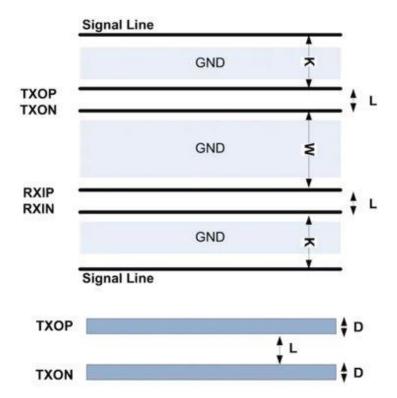
GND



- It is recommended that a GND pattern be placed between TX and RX so that there is no influence between the two lines.
- If the distance between the two lines is wide enough not to affect each other, there is no need for GND Copper.
- The Impedance of the Line depends on the GND processing. When designing this part, Impedance Matching is possible with line thickness and Clearance.



- It is not good for other Digital Lines to pass through the TX and RX lines.
- It is not good to have a high frequency device around (OCS, etc.)



	Min	Тур	MAX	Descriptions
D	6mil	*	12mil	TX+/- and RX+/- Trace thickness, ex) 8mil
L	3	4	10mil	Distance between +/- Differential signal, ex) 4mil
w	20mil	ž.	848	Distance between TX+/- and RX+/- signals, ex) 30mil
K	20mil			Distance between TX+/- and RX+/- signals and others & power, ex) 30mil, separate by GND

- Minimum condition for Ethernet Impedance Line design.
- The impedance of Ethernet is 100 ohms.
- In order to design an accurate Impedance 100 ohm, you should ask the PCB manufacturer to design it.

(Impedance changes depending on Solder Mask, Oz, and process method.)

✓ TEST

■ Compliance

Test Report



	Test Configuration Details
	Application
Nane	D9010ETHC Ethernet
Version	2.72.0.0
	Device Description
Tests100T	No.
Tests1000T	Yes
Tests1000BT	No.
Tests100T_EEE	No.
Tests1008T_EEE	No.
Tests1000BT_EEE	No.
DisturbingSignal	Yes
TxTclk	Yes
DisturberSource	Use Keysight 33250A
ReturnLossTest	Use Vector Network Analyzer
-	Test Session Details
Infiniium SW Version	96,49,09714
Infiniium Model Number	MS0S184A
Infiniium Serial Number	MY55160128
Debug Mode Used	No.
Compliance Limits	IEEE Std. 802.3 Specification (official)
Probe (Channel 2)	Model: N2750A Serial: USS3331201 Atten: Calibrated (18 NOV 2022 15:23:49), Using Cal Atten (9.9742E+00) Skew: Not Calibrated, Using Default Skew
Probe (Channel 3)	Model: User Defined Probe Serial: No Serial Num Atten: Not Calibrated, Using Default Atten (1.00005+00) Skew: Not Calibrated, Using Default Skew
Probe (Channel 4)	Model: User Defined Probe Serial: No Serial Num Atten: Not Calibrated, Using Default Atten (1.0000E+00) Skew: Not Calibrated, Using Default Skew
Last Test Date	2022-11-18 15:37:29 UTC +08:69
Summary of Res	ults

Test	Statistics	Margin Thresholds			
Falled	0	Warning	< 2 %		
Passed	28	Critical	< 0 %		
Total	16				

Pass	# Failed	# Trials	Test Name (click to jump)	Actual Value	Margin	Pass Limits
0	8	1	100 Base-TX, UTP +Vout Differential Output Voltage	955.4 mV	5.4 %	950.0 mV < VALUE < 1.0500 V
0	9	1	100 Base-TX, UTP -Vout Differential Output Voltage	-958.7 eV	0.7 %	950.0 mV < [VALUE] < 1.0500 V
(9	1	100 Base-TX, UTP Signal Amplitude Symmetry	-1.005	37.5 %	980 m < [VALUE] < 1.020
0	Ð	1	100 Base-TX, +Yout Overshoot	-1.2 %	124.0 %	VALUE < 5.0 %
0	8	1	100 Base-TX, -Yout Overshoot	-1.1 X	122.0 X	VALUE < 5.0 %
0	0	1	100 Base-TX, UTP AOI Template	0.000	180.0 X	No Mask Failures
0	8	1	100 Base:TX, AOI +Yout Rise Time	3.809 ns	40.5 %	3.000 ns < VALUE < 5.000 ns
(4)	8	1	100 Base-TX, AOI +Yout Fall Time	3.836 ns	41.8 %	3.000 ns < VALUE < 5.000 ns
0	0	1	180 Base-TX, AOI +Vout Rise/Fall Symmetry	88.89 ps	83.8 %	VALUE < 500.00 ps
0	Ð	1	100 Base-TX, AGI -Vout Rise Time	3.700 ns	35.8 %	3.000 ns < VALUE < 5.000 ns
0	9	1	100 Base-TX, AOI -Vout Fall Time	3.692 ns	34.6 %	3.888 ns < VALUE < 5.888 ns
0	0	1	100 Base-TX, AOI -Vout Rise/Fall Symmetry	135.88 ps	73.0 %	VALUE < 500.00 ps
8	8	1	100 Base-TX, AOI Overall Rise/Fall Symmetry	198.10 ps	68.4 %	VALUE < 500.00 ps
0	0	1	100 Base-TX, Transmit Ditter	374 ps	73.3 %	VALUE < 1.400 ns
0	-8	1	100 Base-TX, Duty Cycle Distortion	54.890 ps	89.0 X	VALUE <= 500.800 ps

- Test conducted at 10/100M
- Power USB Micro B Type

✓ TEST

■ EMI - RE

30 20

10

0 30M





RADIATED EMISSION

2022. 11. 23

										Frequency[Hz]
No.	FREQ RE	ADING QP E	ANT	LOSS	GAIN	RESULT	LIMIT	MARGIN	ANTENNA	TABLE
	[MHz]	[dBuV]	[dB]	[dB]	[dB]	[dBuV/m]	[dBuV/m]	[dB]	[cm]	[DEG]
	Horizont	al								
1 2 3	250.190 625.577 875.830	46.0 33.4 28.5	12.7 19.2 21.7	6.2 10.5 12.2	27. 29. 28.	1 34.0	46.0 46.0 46.0	8.8 12.0 11.8		297 359 174
	Vertical									
4 5	85.290 90.140	46.3 43.0	9.1 10.5	3.5	28. 28.	2 28.9	40.0 43.5	9.3 14.6		0

200M

300M

500M

700M

1G

Source Power – 5 Volt Adapter Power

50M

70M

100M

Test running with maximum Dummy Data transmission and reception